

Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
60V	6mΩ@10V	80A

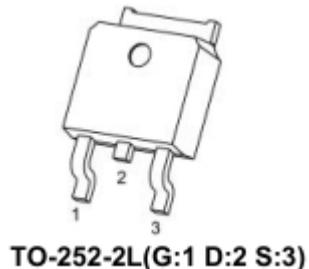
Feature

- Fast Switching
- Low Gate Charge and Rdson
- 100% Single Pulse avalanche energy Test

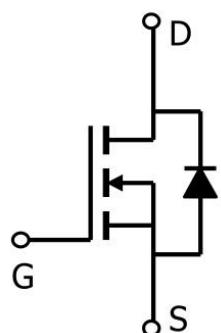
Applications

- Power switching application
- DC-DC Converter
- Power Management

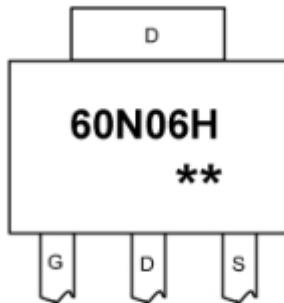
Package



Circuit diagram



Marking



60N06H : Product code
****** : Week code

Absolute maximum ratings

($T_a=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	60	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current($T_c=25^\circ\text{C}$)	I_D	80	A
Pulsed drain current	I_{DM}	320	A
Power dissipation($T_c=25^\circ\text{C}$)	P_D	108	W
Single Pulse Avalanche Energy ¹	E_{AS}	169	mJ
Thermal Resistance-Junction to Case	$R_{\theta JC}$	1.16	$^\circ\text{C}/\text{W}$
Storage Temperature Range	T_{STG}, T_J	-55~ +150	$^\circ\text{C}$



Electrical characteristics

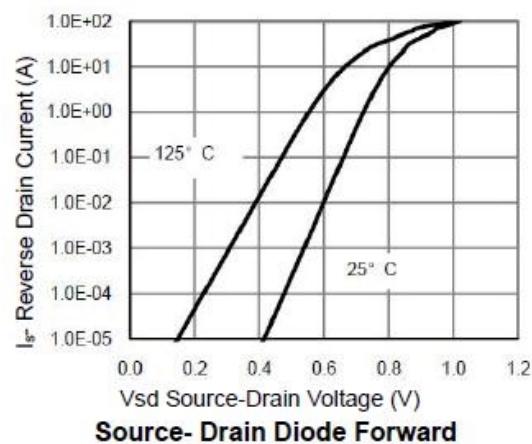
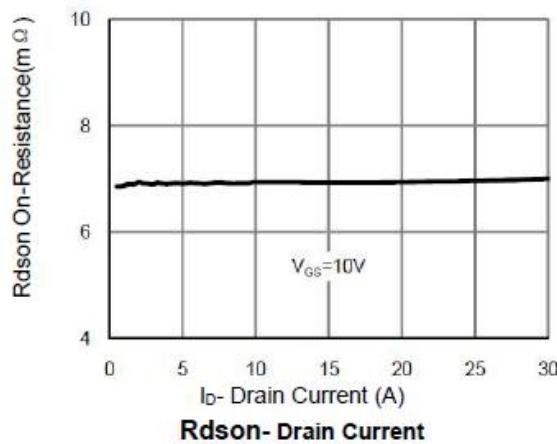
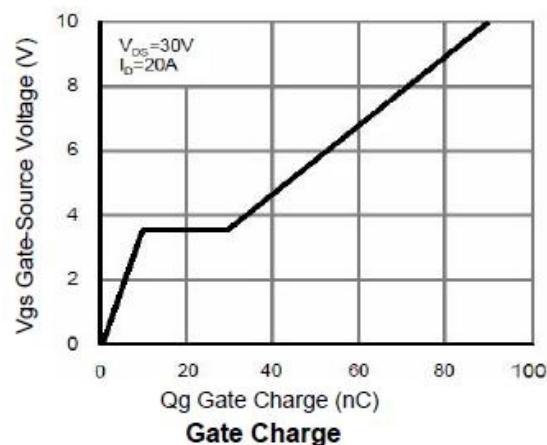
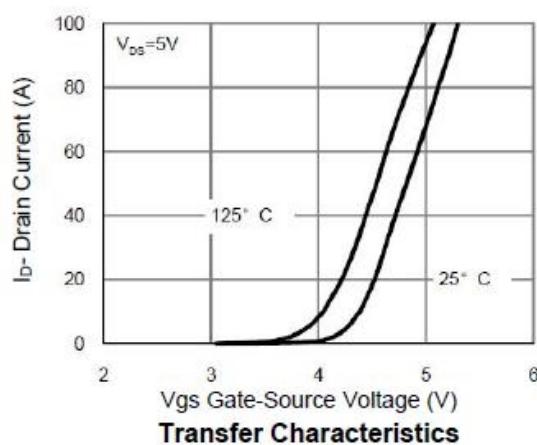
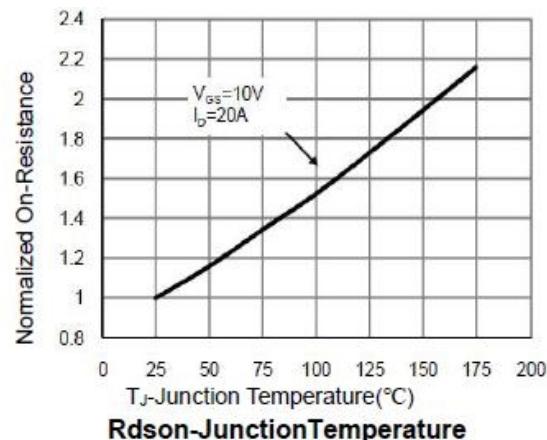
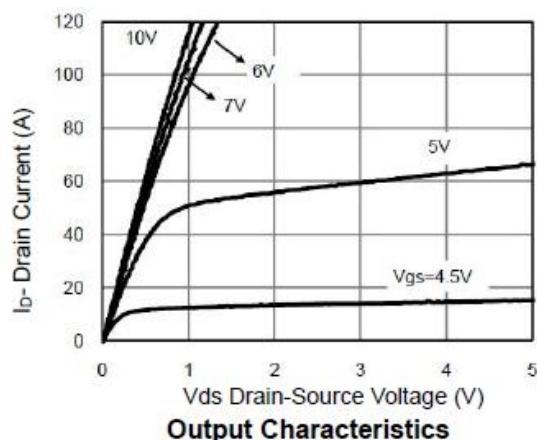
($T_A=25^\circ\text{C}$, unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	$\text{BV}_{(\text{BR})\text{DSS}}$	$V_{GS} = 0\text{V}, I_D = 250\mu\text{A}$	60			V
Drain-source leakage current	I_{DSS}	$V_{DS} = 48\text{V}, V_{GS} = 0\text{V}$			1	μA
Gate-source leakage current	I_{GSS}	$V_{GS} = \pm 20\text{V}, V_{DS} = 0\text{V}$			± 0.1	μA
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	2.0	3.0	4.0	V
Drain-Source On-State Resistance	$R_{DS(\text{on})}$	$V_{GS} = 10\text{V}, I_D = 20\text{A}$		6	7.5	$\text{m}\Omega$
Dynamic Characteristics Reverse						
Input Capacitance	C_{iss}	$V_{DS} = 30\text{V}, V_{GS} = 0\text{V}, f = 1\text{MHz}$		4010		pF
Output Capacitance	C_{oss}			293		
Transfer Capacitance	C_{rss}			215		
Switching Characteristics						
Total Gate Charge	Q_g	$V_{DS} = 30\text{V}, V_{GS} = 10\text{V}, I_D = 20\text{A}$		91		pF
Gate-Source Charge	Q_{gs}			9		
Gate-Drain Charge	Q_{gd}			18.5		
Turn-On Delay Time	$T_{d(on)}$	$V_{GS} = 10\text{V}, V_{DS} = 30\text{V}, R_L = 1\Omega, R_G = 3\Omega$		8.5		nS
Rise Time	T_r			7		
Turn-Off Delay Time	$T_{d(off)}$			41		
Fall Time	t_f			14		
Drain-Source Body Diode Characteristics						
Source-Drain Diode Forward Voltage	V_{SD}	$V_{GS} = 0\text{V}, I_S = 1\text{A}$			1.2	V

Note :

- E_{AS} is tested at starting $T_j = 25^\circ\text{C}$, $V_{DD} = 30\text{V}$, $V_{GS} = 10\text{V}$, $L = 0.5\text{mH}$, $R_g = 25\text{m}\Omega$;

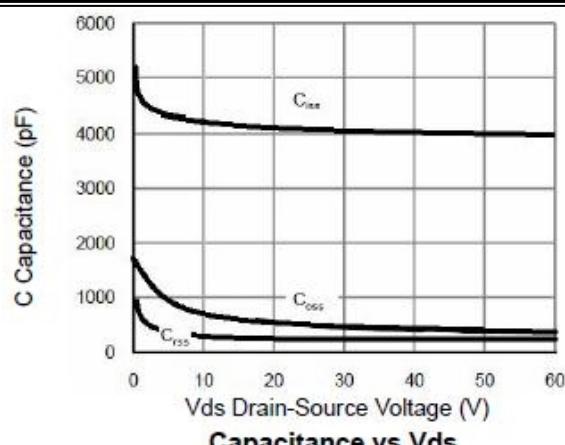
Typical Characteristics



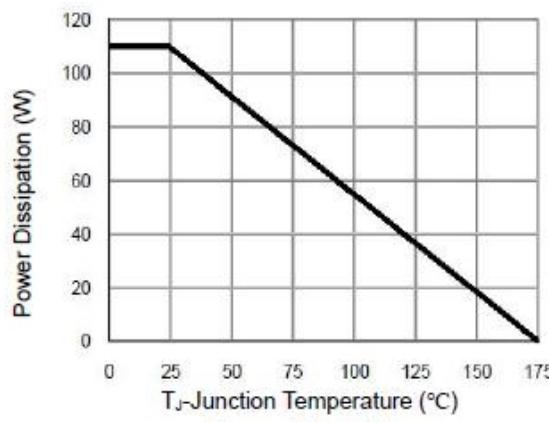


ZL MOSFET

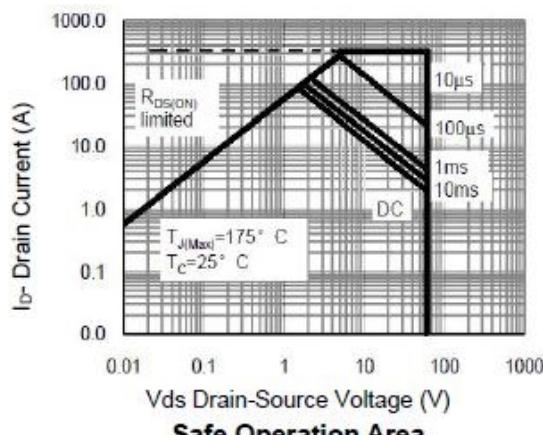
ZL60N06HT



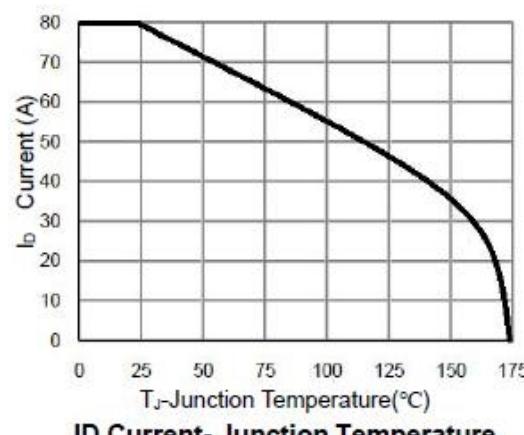
Capacitance vs Vds



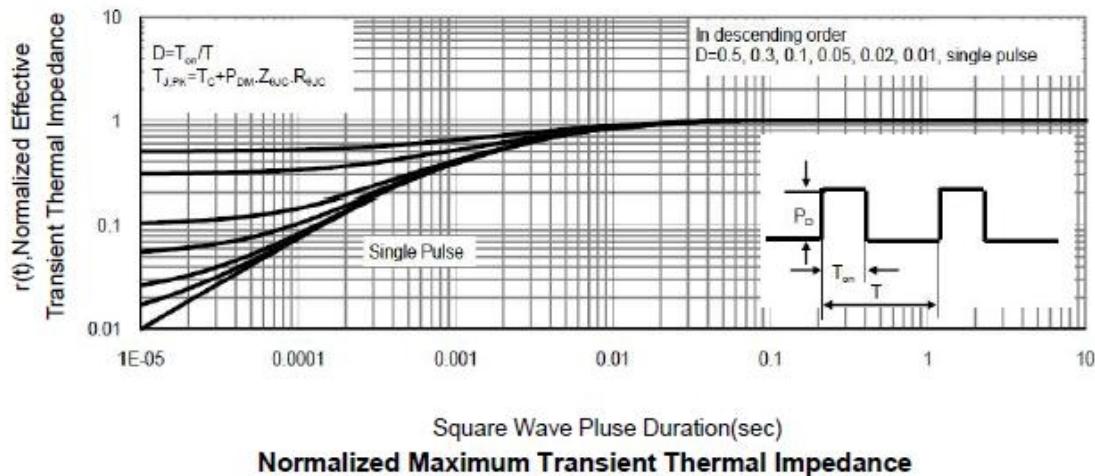
Power De-rating



Safe Operation Area

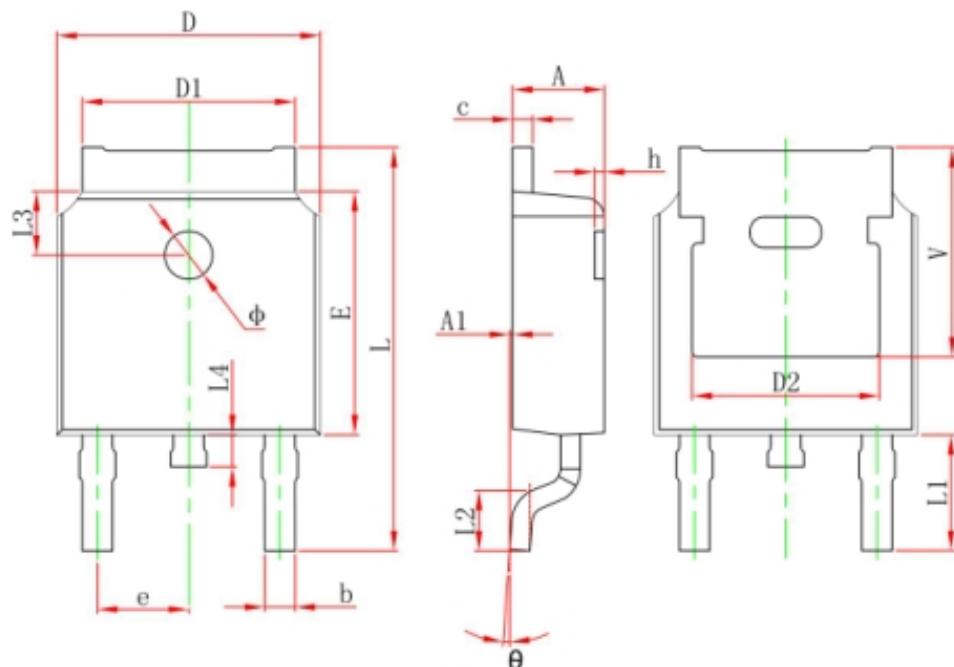


ID Current- Junction Temperature



Normalized Maximum Transient Thermal Impedance

TO-252 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.660	0.860	0.026	0.034
c	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.830 REF.		0.190 REF.	
E	6.000	6.200	0.236	0.244
e	2.186	2.386	0.086	0.094
L	9.800	10.400	0.386	0.409
L1	2.900 REF.		0.114 REF.	
L2	1.400	1.700	0.055	0.067
L3	1.600 REF.		0.063 REF.	
L4	0.600	1.000	0.024	0.039
Φ	1.100	1.300	0.043	0.051
θ	0°	8°	0°	8°
h	0.000	0.300	0.000	0.012
V	5.350 REF.		0.211 REF.	